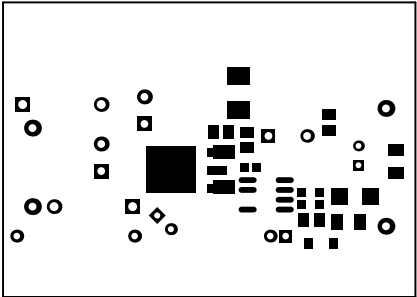
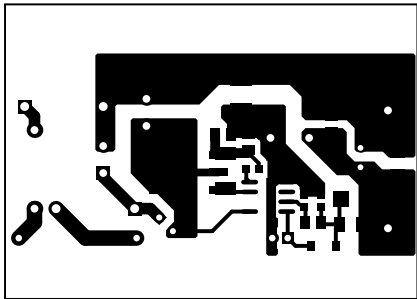


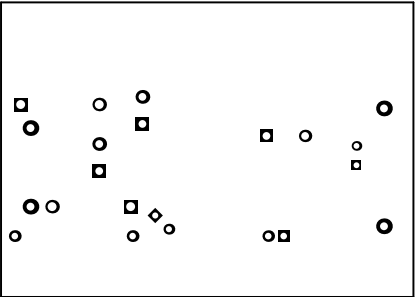
TEXAS INSTRUMENTS



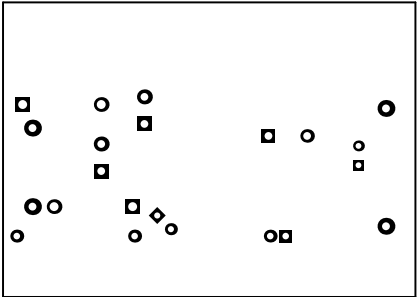
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21487	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 8/27/2018 11:45:36 AM	TEXAS INSTRUMENTS	



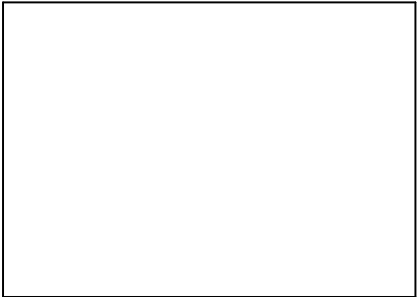
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21487	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 8/27/2018 11:45:37 AM	TEXAS INSTRUMENTS	



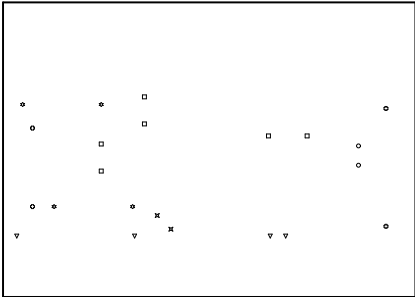
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21487	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 8/27/2018 11:45:38 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21487	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 8/27/2018 11:45:39 AM	TEXAS INSTRUMENTS	

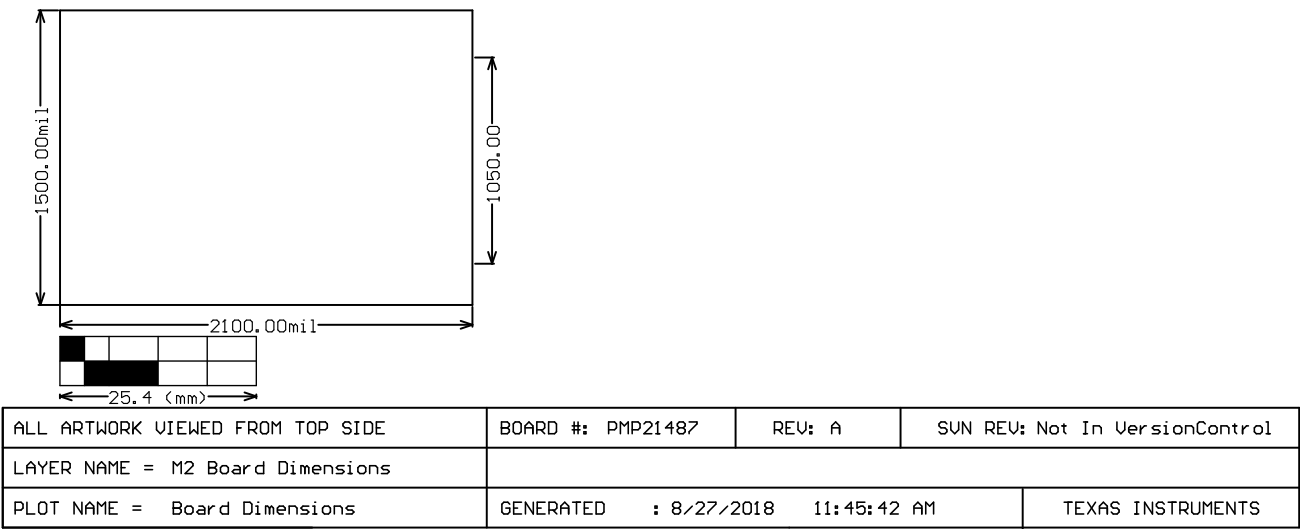


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21487	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 8/27/2018 11:45:40 AM	TEXAS INSTRUMENTS	



Symbol	Count	Hole Size	Plated	Hole Type
○	2	0.750mm (29.53mil)	PTH	Round
⊠	2	0.787mm (31.00mil)	PTH	Round
▽	4	0.850mm (33.47mil)	PTH	Round
⊗	4	1.016mm (40.00mil)	PTH	Round
☆	4	1.150mm (45.28mil)	PTH	Round
□	6	1.000mm (39.37mil)	PTH	Round
22 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP21487	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 8/27/2018 11:45:41 AM	TEXAS INSTRUMENTS	



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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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